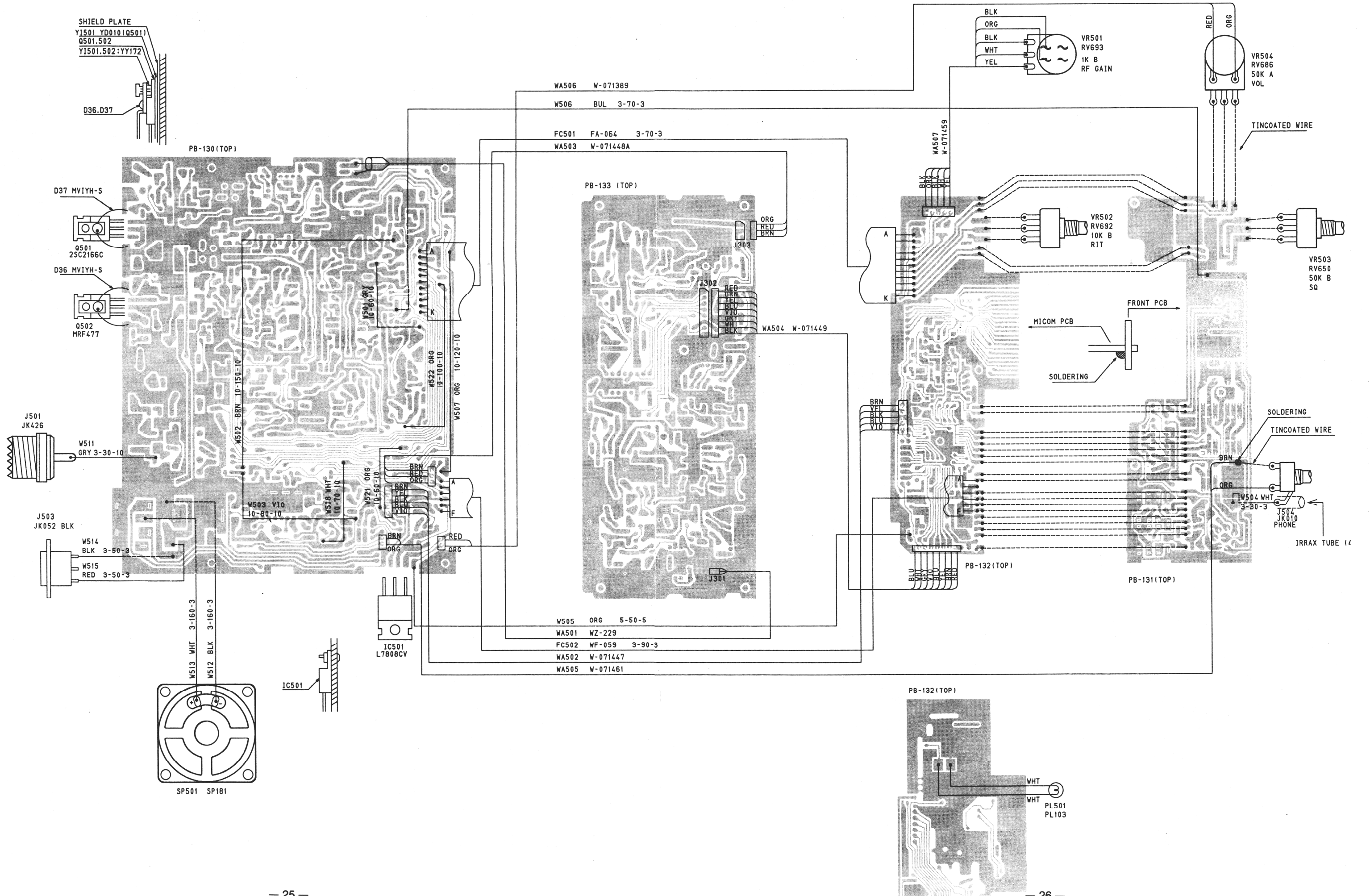
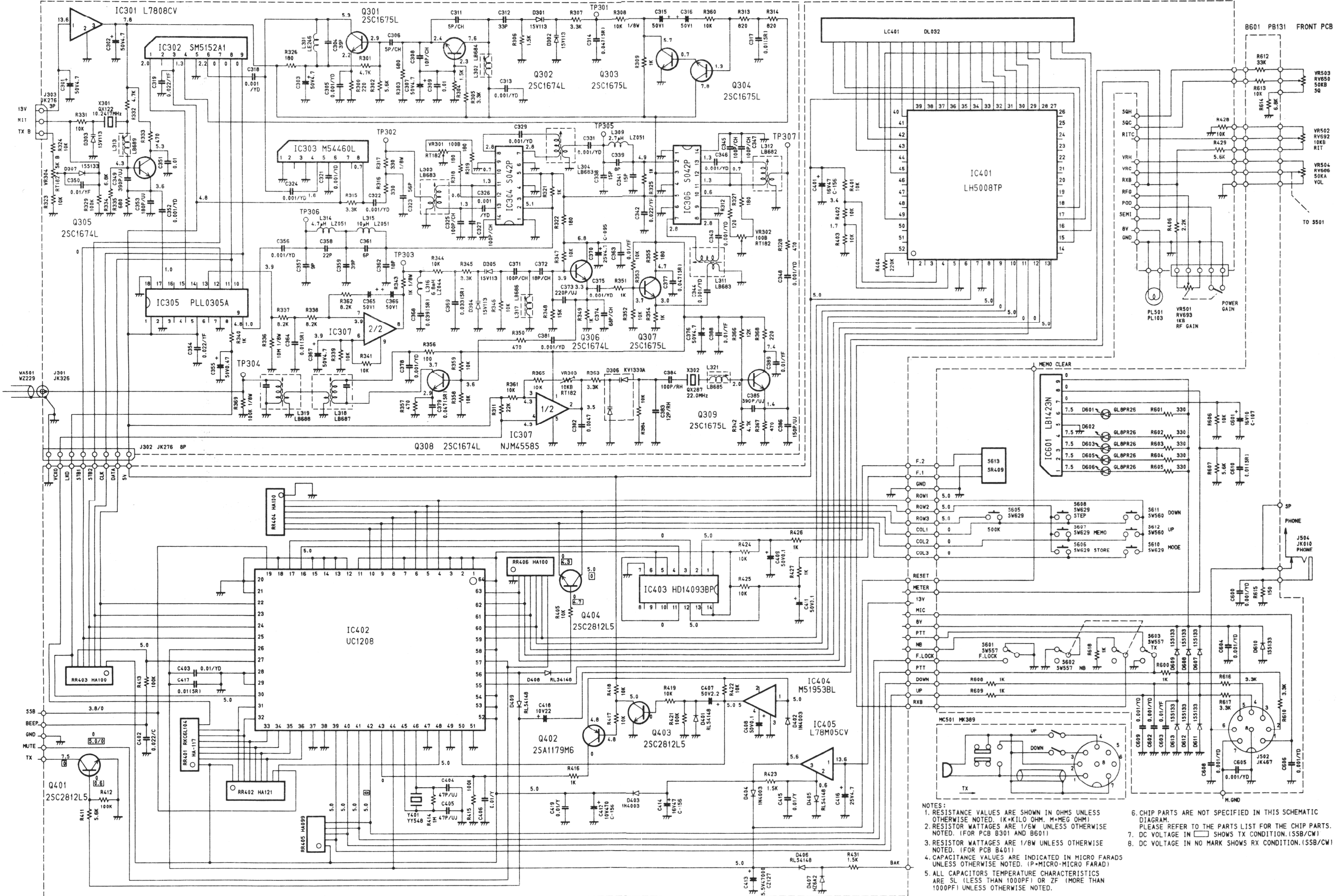


WIRING DIAGRAM

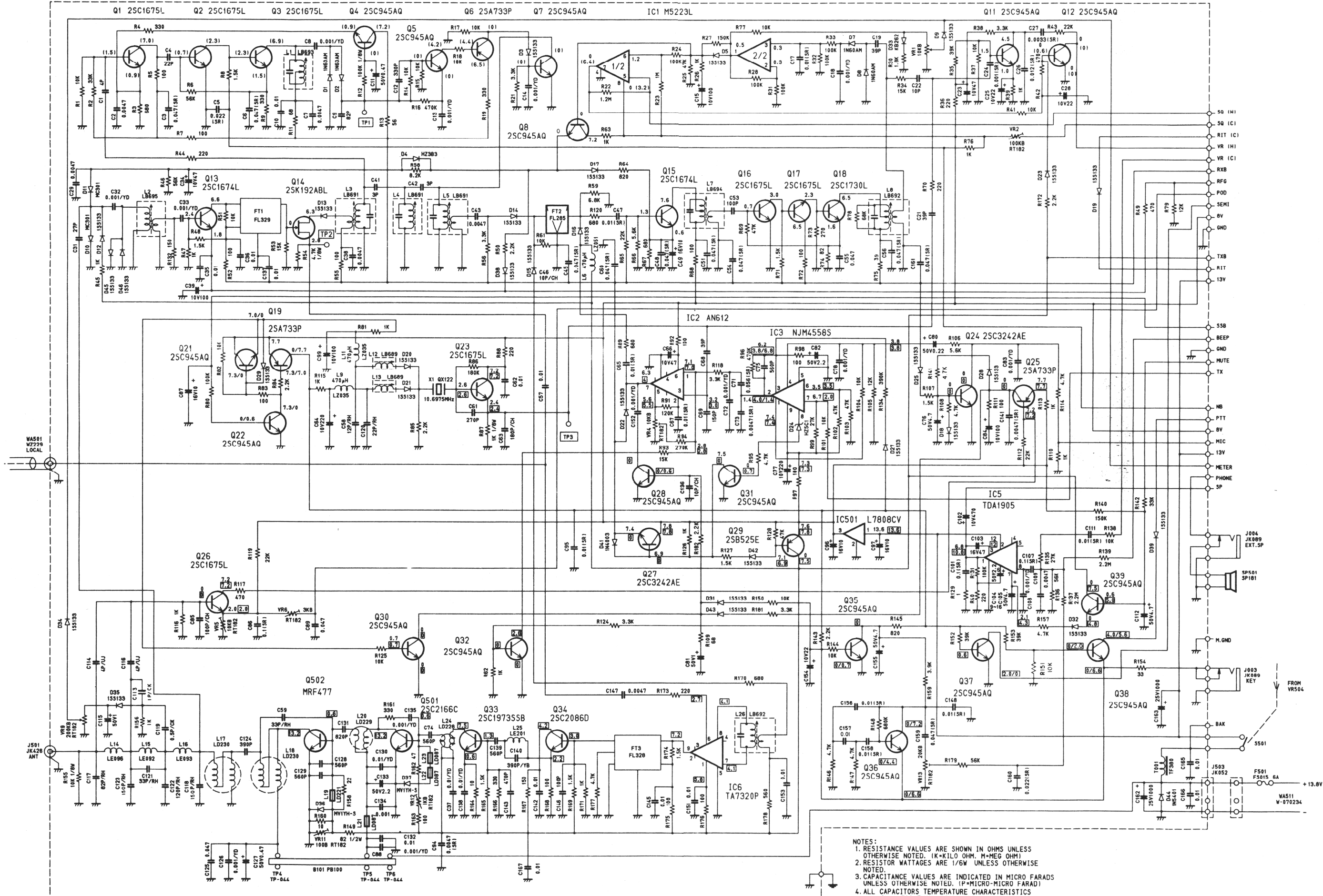




NOTES:
 1. RESISTANCE VALUES ARE SHOWN IN OHMS UNLESS OTHERWISE NOTED. (K=KILO OHM, M=MEG OHM)
 2. RESISTOR WATTAGES ARE 1/6W UNLESS OTHERWISE NOTED. (FOR PCB B301 AND B601)
 3. RESISTOR WATTAGES ARE 1/8W UNLESS OTHERWISE NOTED. (FOR PCB B401)
 4. CAPACITANCE VALUES ARE INDICATED IN MICRO FARADS UNLESS OTHERWISE NOTED. (P=MICRO-MICRO FARAD)
 5. ALL CAPACITORS TEMPERATURE CHARACTERISTICS ARE SL (LESS THAN 100PF) OR ZF (MORE THAN 100PF) UNLESS OTHERWISE NOTED.
 6. CHIP PARTS ARE NOT SPECIFIED IN THIS SCHEMATIC DIAGRAM. PLEASE REFER TO THE PARTS LIST FOR THE CHIP PARTS.
 7. DC VOLTAGE IN [] SHOWS TX CONDITION. (SSB/CW)
 8. DC VOLTAGE IN NO MARK SHOWS RX CONDITION. (SSB/CW)

SCHEMATIC DIAGRAM

B001 PB-130



- NOTES:
1. RESISTANCE VALUES ARE SHOWN IN OHMS UNLESS OTHERWISE NOTED. (K=KILO OHM, M=MEG OHM)
 2. RESISTOR WATTAGES ARE 1/6W UNLESS OTHERWISE NOTED.
 3. CAPACITANCE VALUES ARE INDICATED IN MICRO FARADS UNLESS OTHERWISE NOTED. (P=MICRO-MICRO FARAD)
 4. ALL CAPACITORS TEMPERATURE CHARACTERISTICS ARE SL (LESS THAN 1000PF), 2F (0.047F) OR YF (0.001F-0.039F) UNLESS OTHERWISE NOTED.
 5. DC VOLTAGE IN □ SHOWS TX CONDITION. (SSB/CW)
 6. DC VOLTAGE IN ○ SHOWS RX CONDITION. (SSB/CW)
 7. DC VOLTAGE IN | SHOWS RX CONDITION UNDER OPERATION OF EACH FUNCTION.